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**PATENT**  
**EXPEDITED PROCEDURE**  
**GROUP ART UNIT 2814**

AF#  
Zhu

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicants: JEUN et al.	)	I hereby certify that this paper is being
	)	deposited with the United States Postal
Serial No.: 09/677,558	)	Service, first class postage prepaid,
	)	addressed to: Mail Stop AF,
Title: Semiconductor Power Module Having	)	Commissioner for Patents, P.O. Box
an Electrically Insulating Heat Sink and	)	1450, Alexandria, Virginia 22313-1450,
Method of Manufacturing the Same	)	on the date indicated: <b>January 4, 2006.</b>
	)	
Filed: September 29, 2000	)	
	)	
Group Art Unit: 2814	)	
	)	
Examiner: Nguyen, DiLinh P.	)	
	)	Aaron M. Peters
Atty. Docket Number: 29347/990488	)	Reg. No. 48,801
	)	Attorney for Applicants
	)	
Customer No.: 04743	)	

**AMENDMENT "G" AND RESPONSE TO FINAL OFFICIAL ACTION**

Mail Stop AF  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, Virginia 22313-1450

Sir:

In response to the final official action dated October 4, 2005, the applicants respectfully request that the application be reconsidered in light of the following amendments and remarks.

**Amendments to the claims** are reflected in the listing of claims which begins on page 2 of this paper.

**Remarks** begin on page 4 of this paper.